

STWA50N65DM2AG

Automotive-grade N-channel 650 V, 0.070 Ω typ., 38 A Power MOSFET MDmesh[™] DM2 in TO-247 long leads package

Datasheet - production data

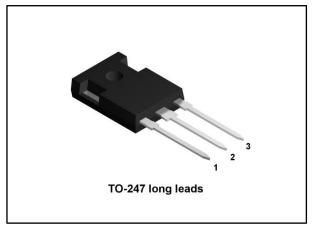
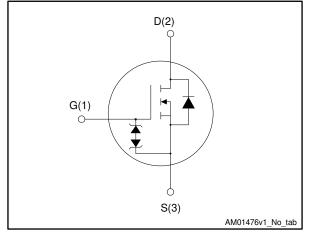


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ртот
STWA50N65DM2AG	650 V	0.087 Ω	38 A	300 W

- AEC-Q101 gualified
- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (trr) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing	
STWA50N65DM2AG	50N65DM2	TO-247 long leads	Tube	



The HTRB test was performed at 80% $V_{(BR)DSS}$ in compliance with AEC-Q101 rev. C. All the other tests were performed according to rev. D.

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{GS}	Gate-source voltage	±25	V	
Ip	Drain current (continuous) at T _{case} = 25 °C	38	А	
U	Drain current (continuous) at T _{case} = 100 °C	24	A	
IDM ⁽¹⁾	Drain current (pulsed)	110	А	
Ртот	Total dissipation at T _{case} = 25 °C	300	W	
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns	
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns	
T _{stg}	Storage temperature range	-55 to 150	°C	
Tj	Operating junction temperature range	-55 10 150	°C	

Notes:

 $^{\left(1\right)}$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 38 A, di/dt=800 A/µs; V_{DS} peak < V_(BR)DSS, V_{DD} = 80% V_{(BR)DSS}.

 $^{(3)}$ V_DS ≤ 520 V.

Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.42	
R _{thj-amb}	R _{thj-amb} Thermal resistance junction-ambient		°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar	Avalanche current, repetitive or not repetitive	5	А
Eas ⁽¹⁾	¹⁾ Single pulse avalanche energy		mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V, I_D = 1 mA$	650			V
	Zoro goto voltago drain	$V_{GS} = 0 V, V_{DS} = 650 V$			10	
IDSS	Zero gate voltage drain current	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = 650 \ V, \\ T_{case} = 125 \ ^{\circ}C \ ^{(1)} \end{array}$			100	μA
Igss	Gate-body leakage current	$V_{\text{DS}}=0~V,~V_{\text{GS}}=\pm25~V$			±5	μA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 19 \text{ A}$		0.070	0.087	Ω

Notes:

⁽¹⁾Defined by design, not subject to production test

Symbol	bol Parameter Test conditions		Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	3200	-	
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	130	-	рF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	3	-	P
Coss eq. ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 520 V, V_{GS} = 0 V	-	256	-	pF
Rg	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
Qg	Total gate charge	$V_{DD} = 520 V, I_D = 38 A,$	-	69	-	
Qgs	Gate-source charge	V _{GS} = 0 to 10 V (see <i>Figure 15: "Test circuit for</i>	-	18	-	nC
Q _{gd}	Gate-drain charge	gate charge behavior")	-	34	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.



Electrical characteristics

_	Table 7: Switching times						
Symbol	Symbol Parameter Test conditions					Unit	
td(on)	Turn-on delay time	$V_{DD} = 325 V, I_D = 19 A$	-	22.5	-		
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	21	-		
td(off)	Turn-off delay time	resistive load switching times"	-	89	-	ns	
tr	Fall time	and Figure 19: "Switching time waveform")	-	10.5	-		

Table 8: Source-drain diode

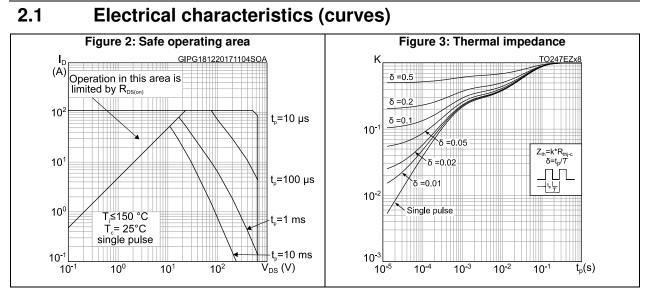
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		38	А
Isdm ⁽¹⁾	Source-drain current (pulsed)				110	А
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS}=0~V,~I_{SD}=38~A$	-		1.6	۷
trr	Reverse recovery time	I _{SD} = 38 A, di/dt = 100 A/µs,	-	150		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see <i>Figure 16:</i> " <i>Test circuit for</i>	-	0.96		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	12.8		А
t _{rr}	Reverse recovery time	I _{SD} = 38 A, di/dt = 100 A/µs,	-	245		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	2.7		μC
IRRM	Reverse recovery current	inductive load switching and diode recovery times")	-	22		А

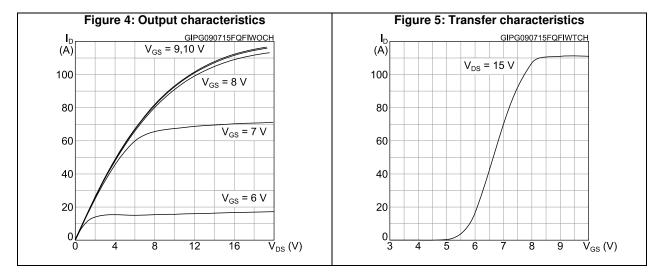
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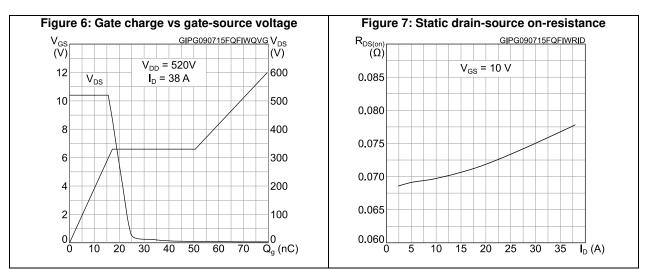
 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.









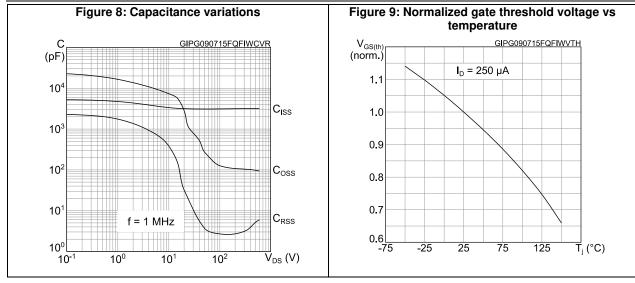
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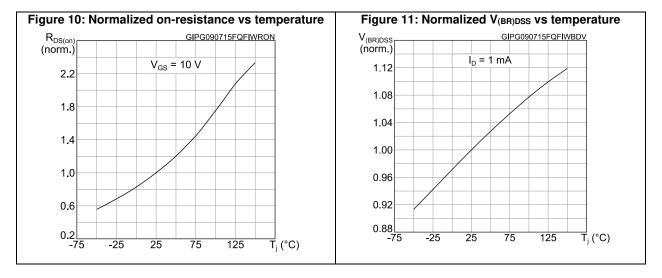


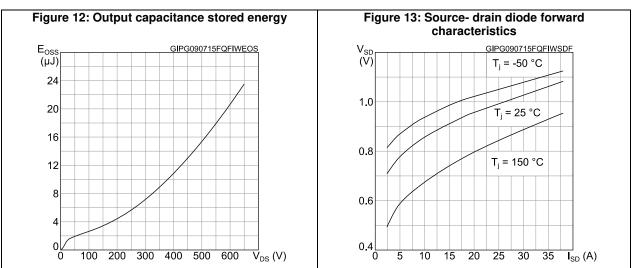
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Electrical characteristics

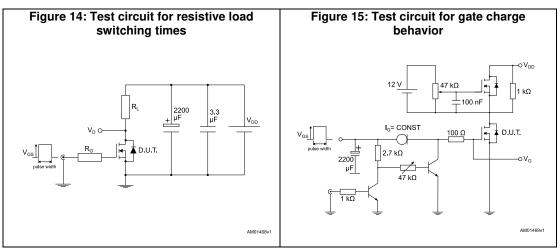


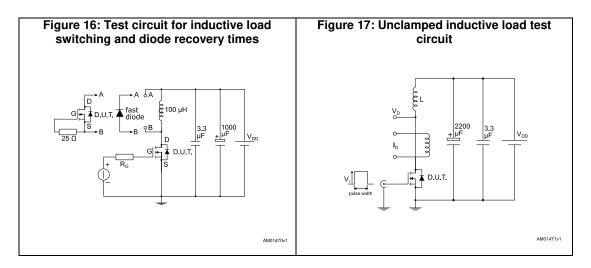


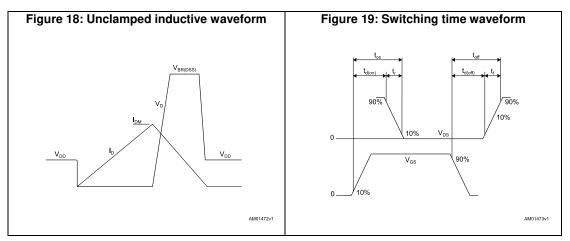


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3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 long leads package information

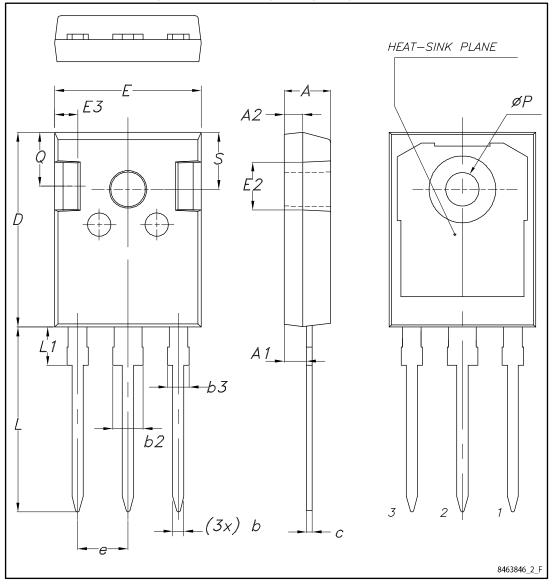


Figure 20: TO-247 long leads package outline



Package information

STWA50N65DM2AG

Table 9: TO-247 long leads package mechanical data					
Dim		mm			
Dim.	Min.	Тур.	Max.		
A	4.90	5.00	5.10		
A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
b	1.16		1.26		
b2			3.25		
b3			2.25		
С	0.59		0.66		
D	20.90	21.00	21.10		
E	15.70	15.80	15.90		
E2	4.90	5.00	5.10		
E3	2.40	2.50	2.60		
е	5.34	5.44	5.54		
L	19.80	19.92	20.10		
L1			4.30		
Р	3.50	3.60	3.70		
Q	5.60		6.00		
S	6.05	6.15	6.25		



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5 Revision history

Date	Revision	Changes
10-Jan-2017	1	Initial release
18-Dec-2017	2	 Datasheet promoted from preliminary data to production data. Modified Table 2: "Absolute maximum ratings", Table 4: "Avalanche characteristics", Table 6: "Dynamic" and Table 8: "Source-drain diode". Modified Figure 2: "Safe operating area". Minor text changes.



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